Audio sound processor with **BBE**® BH3868BFS

BH3868BFS is a Audio sound processor IC developed for TV. This IC is built-in volume, balance, tone, surround, BBE processor and AGC. This IC can be easily controlled by tow-wire serial control (I²C BUS).

* BBE is a registered trade mark of BBE Sound Inc.

Note: I²C BUS is a registered trade mark of Philips

Applications

Suitable for TV, TV-radio, PC-TV, mini-component and car audio system, etc.

Features

- 1) Volume (main volume), balance (right/left), tone (bass and treble), surround (mode and effect), BBE processor (effect) can be controlled by I²C-BUS.
- 2) Volume is VCA with low distortion rate and low noise and can restrain the step noise.
- 3) The reference voltage source is stable, only a few external devices are required because I/O buffer is contained, and the package is suitable for space-saving design for SSOP-A32.
- 4) Sound spread can be controlled by the matrix surround and effect adjustment.
- 5) The built-in AGC circuit can absorb the volume difference between input sources.
- 6) The contained BBE processor, which reproduce an original sound, controls the effect.

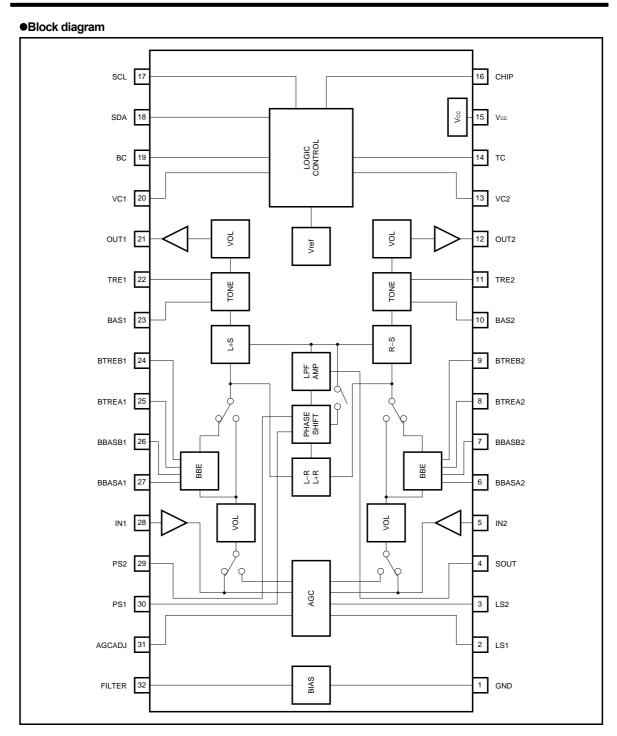
●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Impressed voltage	Vcc	10.0	V
Power dissipation	Pd	850*	mW
Operating temperature range	Topr	-40 to +85	°C
Storage temperature range	Tstg	-55 to +150	°C

^{*} When mounted on a glass epoxy board 70mm \times 70mm \times 1.6mm. Reduced by 6.8mW for each increase in Ta of 1°C over 25°C.

■Recommended operating conditions (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power supply voltage	Vcc	7.0	_	9.5	V



●Pin descriptions

Pin No. Pin name Function GND Ground terminal	Pin No. Pin name Function							
LS1 ALC detector terminal at suppression side 3 LS2 ALC detector terminal at amplification side 4 SOUT Surround signal output terminal 5 IN2 2ch sound signal input terminal 6 BBASA2 2chBBE contour frequency setting terminal 7 BBASB2 2chBBE contour frequency setting terminal 8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal								
3 LS2 ALC detector terminal at amplification side 4 SOUT Surround signal output terminal 5 IN2 2ch sound signal input terminal 6 BBASA2 2chBBE contour frequency setting terminal 7 BBASB2 2chBBE contour frequency setting terminal 8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal			Ground terminal					
4 SOUT Surround signal output terminal 5 IN2 2ch sound signal input terminal 6 BBASA2 2chBBE contour frequency setting terminal 7 BBASB2 2chBBE contour frequency setting terminal 8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE contour frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	2	LS1	ALC detector terminal at suppression side					
5 IN2 2ch sound signal input terminal 6 BBASA2 2chBBE contour frequency setting terminal 7 BBASB2 2chBBE contour frequency setting terminal 8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE contour frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	3	LS2	ALC detector terminal at amplification side					
6 BBASA2 2chBBE contour frequency setting terminal 7 BBASB2 2chBBE contour frequency setting terminal 8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	4	SOUT	Surround signal output terminal					
BBASB2 2chBBE contour frequency setting terminal BTREA2 2chBBE process frequency setting terminal BTREB2 2chBBE process frequency setting terminal DBAS2 2ch bass fc setting terminal TRE2 2ch treble fc setting terminal CUT2 2ch sound signal output terminal TC Treble control terminal TC Treble control terminal TC Power supply terminal CHIP Chip select terminal TC SCL I²C clock input terminal BC Bass control terminal TC Tc data input terminal TC Tc data input terminal TC Tc bass control terminal TC Tc clock input terminal TC Tc clo	5	IN2	2ch sound signal input terminal					
8 BTREA2 2chBBE process frequency setting terminal 9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	6	BBASA2	2chBBE contour frequency setting terminal					
9 BTREB2 2chBBE process frequency setting terminal 10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	7	BBASB2	2chBBE contour frequency setting terminal					
10 BAS2 2ch bass fc setting terminal 11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	8	BTREA2	2chBBE process frequency setting terminal					
11 TRE2 2ch treble fc setting terminal 12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	9	BTREB2	2chBBE process frequency setting terminal					
12 OUT2 2ch sound signal output terminal 13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE contour frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	10	BAS2	2ch bass fc setting terminal					
13 VC2 2ch volume control terminal 14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE contour frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	11	TRE2	2ch treble fc setting terminal					
14 TC Treble control terminal 15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	12	OUT2	2ch sound signal output terminal					
15 Vcc Power supply terminal 16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	13	VC2	2ch volume control terminal					
16 CHIP Chip select terminal 17 SCL I²C clock input terminal 18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal	14	TC	Treble control terminal					
17 SCL I ² C clock input terminal 18 SDA I ² C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	15	Vcc	Power supply terminal					
18 SDA I²C data input terminal 19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	16	CHIP	Chip select terminal					
19 BC Bass control terminal 20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	17	SCL	I ² C clock input terminal					
20 VC1 1ch volume control terminal 21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	18	SDA	I ² C data input terminal					
21 OUT1 1ch sound signal output terminal 22 TRE1 1ch treble fc setting terminal 23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	19	ВС	Bass control terminal					
TRE1 1ch treble fc setting terminal BAS1 1ch bass fc setting terminal 1chBBE process frequency setting terminal BTREB1 1chBBE process frequency setting terminal BTREA1 1chBBE process frequency setting terminal BBASB1 1chBBE contour frequency setting terminal BBASA1 1chBBE contour frequency setting terminal IN1 1ch sound signal input terminal PS1 1st phase shift setting terminal PS2 2nd phase shift setting terminal AGCADJ AGC suppression level setting terminal	20	VC1	1ch volume control terminal					
23 BAS1 1ch bass fc setting terminal 24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	21	OUT1	1ch sound signal output terminal					
24 BTREB1 1chBBE process frequency setting terminal 25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	22	TRE1	1ch treble fc setting terminal					
25 BTREA1 1chBBE process frequency setting terminal 26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	23	BAS1	1ch bass fc setting terminal					
26 BBASB1 1chBBE contour frequency setting terminal 27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	24	BTREB1	1chBBE process frequency setting terminal					
27 BBASA1 1chBBE contour frequency setting terminal 28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	25	BTREA1	1chBBE process frequency setting terminal					
28 IN1 1ch sound signal input terminal 29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	26	BBASB1	1chBBE contour frequency setting terminal					
29 PS1 1st phase shift setting terminal 30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	27	BBASA1	1chBBE contour frequency setting terminal					
30 PS2 2nd phase shift setting terminal 31 AGCADJ AGC suppression level setting terminal	28	IN1	1ch sound signal input terminal					
31 AGCADJ AGC suppression level setting terminal	29	PS1	1st phase shift setting terminal					
	30	PS2	2nd phase shift setting terminal					
32 FILTER Filter terminal	31	AGCADJ	AGC suppression level setting terminal					
	32	FILTER	Filter terminal					

●Input output circuits

The terminal voltage shall be on when the data 0V volume=minimum, tone=flat, BBE=OFF, surround=OFF and AGC=OFF after the power supply Vcc=9.0(V) has been turned on, and any external devices shall comply with the measurement circuit diagram.

Pin. No	ent circuit dia Pin name	Terminal voltage	Equivalent circuit	Description
2	LS1	0V	2pin 430 \$	Terminal to set a time constant at a side for suppressing a signal level of AGC.
3	LS2	ov	Vcc O 20k 20k 3pin GND O	Terminal to set a time constant at a side for amplifying a signal level of AGC.
4	SOUT	4.5V	4pin Oliver 10k	Terminal for output of surround and pseudo stereo and to set a frequency characteristic.
5 28	IN2 IN1	4.5V	Spin 28pin Salak	Terminal for sound signal input.

Pin. No	Pin name	Terminal voltage	Equivalent circuit	Description
6 27	BBASA2 BBASA1	4.5V	6pin 27pin 21.5k	Terminal to set a contour frequency of BBE.
7 26	BBASB2 BBASB1	4.5V	7pin 26pin 200 S	Terminal to set a contour frequency of BBE.
8 25	BTREA2 BTREA1	4.5V	Vcc O	Terminal to set a process frequency of BBE.
9 24	BTREB2 BTREB1	4.5V	9pin 24pin 200 S	Terminal to set a process frequency of BBE.

Pin. No	Pin name	Terminal voltage	Equivalent circuit	Description
10 23	BAS2 BAS1	4.5V	Vcc O O O O O O O O O O O O O O O O O O	Terminal to the cutoff frequency of bass tone control.
11 22	TRE2 TRE1	4.5V	Vcc O	Terminal to the cutoff frequency of treble tone control.
12 21	OUT2 OUT1	4.5V	200 200 200 200 200 200 200 200 200 200	Terminal for sound signal output.
13 20	VC2 VC1	0V	Vcc Ο	Terminal equipped with an external circuit to prevent a shock sound upon volume switching.

Pin. No	Pin name	Terminal voltage	Equivalent circuit	Description
14 19	TC BC	1.94V	14pin 30kΩ D / A GND O	Terminal equipped with an external circuit to prevent a shock sound upon tone switching.
16	CHIP	_	250k 16pin	Chip select terminal.
17	SCL	_	Vcc O	Clock input terminal for I ² C BUS controller.
18	SDA	-	18pin 550	Data input terminal for I ² C BUS controller.

Pin. No	Pin name	Terminal voltage	Equivalent circuit	Description
29	PS1	4.5V	29pin	Terminal to set the 1st phase shift.
30	PS2	4.5V	Vcc ○	Terminal to set the 2nd phase shift.
31	AGCADJ	-	20k \$ 20k 31pin GND 0	Terminal to set the cut levle of AGC.
32	FILTER	4.5V	Vcc	Filter terminal.

•Electrical characteristics

(unless otherwise noted, Ta=25°C, Vcc=9V, f=1kHz, BW=20kHz, VOL=MAX, surround = OFF, TONE=FLAT, AGC=OFF, BBE=OFF, AGCADJ=3.45V, RR=600 Ω , RL=10k Ω)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Current upon no signal	lα	-	30	45	mA	No signal	
Maximum input	Vım	2.8	3.0	_	Vrms	THD=1%, VOL=-20dB (ATT)	
Maximum output	Vом	2.2	2.5	_	Vrms	THD=1%	
Voltage gain	G∨	-1.5	0	1.5	dB	V _{IN} =1V _{rms}	
Maximum attenuation	ATT	90	110	_	dB	V _{IN} =1V _{rms}	
Cross-talk	Vст	70	80	_	dB	V _{IN} =1V _{rms}	
Dana andrei andrei	VBMax.	12	15	18	dB	100Hz, V _{IN} =100mV _{rms}	
Bass control range	VBMin.	-18	-15	-12	dB	100Hz, V _{IN} =100mV _{rms}	
Tueble control reces	VTMax.	12	15	18	dB	10kHz, V _{IN} =100mVrms	
Treble control range	VTMin.	-18	-15	-12	dB	10kHz, V _{IN} =100mVrms	
Surround effect control range	Gsr	7	10	13	dB	V _{IN} =1V _{rms}	
BBE Contour control range	Gps	9	10	11	dB	100Hz, V _{IN} =100mV _{rms}	
BBE Process control range	Gрн	9	10	11	dB	10kHz, V _{IN} =100mV _{rms}	
AGC I/O level 1	Agc ₁	0.7	1.0	1.4	mVrms	V _{IN} =1.0mV _{rms}	
AGC I/O level 2	Agc2	50	75	100	mVrms	V _{IN} =50mV _{rms}	
AGC I/O level 3	Адсз	150	200	250	mVrms	V _{IN} =200mV _{rms}	
AGC I/O level 4	Agc4	200	280	360	mVrms	V _{IN} =1.0Vrms	
Total harmonic distortion	THD	-	0.01	0.1	%	Vo=0.5Vrms, BPF=400Hz~30kHz	
Output noise voltage	V _{NO1}	-	48	75	μVrms	No signal, VOL=Max. Rg=0 *	
Residual output noise voltage	VMno	-	2.5	10	μVrms	No signal, VOL=-∞, Rg=0 *	
Channel balance	GCA	-1.5	0	1.5	dB	Measured based on CH1.	
Input impedance	Rin	20	30	40	kΩ	f=1kHz	
Output impedance	Rоит	-	-	10	Ω	f=1kHz	
Ripple rejection	RR	40	-	_	V	f=100Hz, V _{RR} =100mV _{rms}	
Input voltage "H"	ViH	3	5	5.5	V	SCL, SDA	
Input voltage "L"	VIL	-0.5	0	1.5	V	SCL, SDA	

^{*} Measured by VP-9690A of Matsushita (detection of mean value and indication of root-mean-value).

© Radiation resistance is not included in the design.

© The I/O phase of signal is the same.

●Control signal specification

(1) Electrical specifications and timing for bus lines and I/O stages

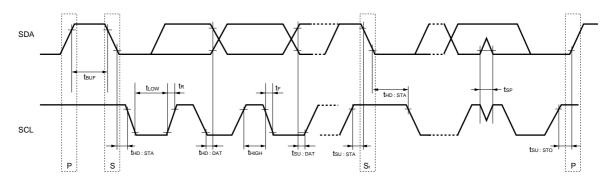


Fig.1 Definition of timing on the I²C BUS

Table B Characteristics of the SDA and SCL bus lines for I²C BUS devices

Parameter	Symbol	Min.	Max.	Unit
SCL clock fequency	fscL	0	100	kHz
Bus free time between a STOP and START condition	tBUF	4.7	_	μs
Hold time (repeated) START condition. After this period, the first clock pulse is generated	thd; sta	4.0	-	μs
LOW period of the SCL clock	tLOW	4.7	_	μs
HIGH period of the SCL clock	thigh	4.0	_	μs
Set-up time for a repeated START condition	tsu; sta	4.7	_	μs
Data hold time	thd; dat	0*	_	μs
Data set-up time	tsu; dat	250	_	ns
Rise time of both SDA and SCL signals	tR	_	1000	ns
Fall time of both SDA and SCL signals	tr	_	300	ns
Set-up time for STOP condition	tsu; sto	4.0	_	μs
Capacitive load for each bus line	Cb	_	400	pF

All values referred to VIH min. and VIL max. Levels (see Table C).

* A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the VIH min. of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

Table C Characteristics of the SDA and SCL I/O stages for I²C BUS devices

Parameter	Symbol	Min.	Max.	Unit
LOW level input voltage :				
fixed input levels	VIL	-0.5	1.5	V
Vpp-related input levels		(-0.5)	(0.3 VDD)	
HIGH level input voltage :				
fixed input levels	VIH	3.0	*1	V
V _{DD} -related input levels		(0.7 V _{DD})	(*1)	
Hysteresis of Schmitt trigger inputs :				
Fixed input levels	Vhys	n/a	n/a	V
Vpp-related input levels		(n/a)	(n/a)	
Pulse width of spikes which must be suppressed by the input filter.	tsp	n/a	n/a	ns
LOW level output voltage (open drain or open collector) :				
at 3mA sink current	Vol1	0	0.4	V
at 6mA sink current	(Vol2)	(n/a)	(n/a)	
Output fall time from $V_{\text{IH min.}}$ to $V_{\text{IL max.}}$ with a bus capacitance from 10pF to 400pF :				
with up to 3mA sink current at Vol1	tor	_	250*²	ns
with up to 6mA sink current at Vol2		(n/a)	(n/a)	
Input current each I/O pin with an input voltage between 0.4V and 0.9 VDDmax.	lı	-10	10	μΑ
Capacitance for each I/O pin.	Cı	_	10	pF

n/a = not applicable

The above-mentioned characteristics are theoretical values based on IC design and the delivery inspection does not guarantee anything. If any trouble is made, we will take necessary arrangements and actions in our faith.

^{*1} maximum V_{IH}=V_{DDmax.} + 0.5V

^{**}T maximum 'New Dumak + 0.39

*2 Cb=capacitance of one bus line in pF. Note that the maximum tr for the SDA and SCL bus lines quoted in Table B (300ns) is longer than the specified maximum tor for the output stages (250ns). This allows series protection resistors (Rs) to be connected between the SDA/SCL pins and the SDA/SCL bus lines as shown in Fig.1 without exceeding the maximum specified tr.

Audio ICs

(2) I²C BUS format

		MSB	LSB		MSB	LSB		MSB	LSB		
	S	Slave Address		Α	Select Address		Α	Data		Α	Р
-	1hit	8hit		1hit	8hit		1hit	8hit		1hit	1hit

• S =Start condition (Recognition of start bit)

• Slave Address = Recognition of IC. The high order 7 bits are optional.

The least significant bit is "L" for writing.

• A = Acknowledge bit (Recognition of acknowledgement)

• Select Address = Selection of 1ch volume, 2ch volume, BBE effect, bass+BBE, treble+MUTE and

AGC+matrix surround.

Data = Data on volume and tone.

• P =Stop condition (Recognition of stop bit)

Slave Address of BH3868BFS

Fixing 16pin to Vcc

MSB				LSB						
D7	D6	D5	D4	D3	D2	D1	R/W			
1	0	0	0	0	0	1	0			

Making 16pin OPEN

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	R/W
1	0	0	0	0	0	0	0

(3) Setting of Select Address

	Parameter	MSB							LSB
	Parameter	D7	D6	D5	D4	D3	D2	D1	D0
0	1ch Volume	0	0	0	0	0	0	0	0
1	2ch Volume	0	0	0	0	0	0	0	1
2	BBE Processor	0	0	0	0	0	0	1	0
3	BBE, Bass	0	0	0	0	0	0	1	1
4	MUTE, Treble	0	0	0	0	0	1	0	0
5	AGC, Surround	0	0	0	0	0	1	0	1

Upon transferring consecutive data, the select address circulates because of the automatic increment function as follows: $0\rightarrow1\rightarrow2\rightarrow3\rightarrow4\rightarrow5$

The circulation starts from the select address specified first. It doesn't patrol from selection address 5 to selection address 0.

(4) Data Configuration

	Б ,	MSB							LSB		
	Parameter	D7	D6	D5	D4	D3	D2	D1	D0		
0	1ch Volume		1ch Volun					olume			
1	2ch Volume	2ch Volume									
2	BBE Processor		Pro	cess			Cor	ntour			
3	BBE, Bass	BBE				Bass					
4	MUTE, Treble	MUTE Treble									
5	AGC, Surround	AGC SON SSTE SMON LOOP Surround Effect					ect				

Volume: all H: ATT 0dB

all L: ATT -∞dB

BBE Processor: all H: Max.

all L: Min.

Bass / Treble: all H: Max.

all L: Min.

Surround Effect: all H: Max.

all L: Min.

BBE: H:ON L:OFF

AGC: H:ON L:OFF(AGC:Auto Gain Control)

MUTE: H:ON L:OFF

LOOP: H: ON L: OFF(LOOP: surround effect enhanceer)

 SSTE:
 H: ON
 L: OFF(SSTE: Surround STEreo)

 SMON:
 H: ON
 L: OFF(SMON: Surround MONoral)

 SON:
 H: ON
 L: OFF(SON: Surround ON)

Note: It is advisable to apply MUTE upon switching the mode and gain of BBE and SURROUND.

Volume Gain setting list

Gain (dB)	Hex. Notation	D7	D6	D5	D4	D3	D2	D1	D0
0	FFH	1	1	1	1	1	1	1	1
-1	EAH	1	1	1	0	1	0	1	0
-2	DFH	1	1	0	1	1	1	1	1
-3	D6H	1	1	0	1	0	1	1	0
-4	CFH	1	1	0	0	1	1	1	1
-5	C8H	1	1	0	0	1	0	0	0
-6	C2H	1	1	0	0	0	0	1	0
-7	В9Н	1	0	1	1	1	0	0	1
-8	B8H	1	0	1	1	1	0	0	0
-9	ВЗН	1	0	1	1	0	0	1	1
-10	AEH	1	0	1	0	1	1	1	0
-11	AAH	1	0	1	0	1	0	1	0
-12	A6H	1	0	1	0	0	1	1	0
-13	A2H	1	0	1	0	0	0	1	0
-14	9EH	1	0	0	1	1	1	1	0
-15	9AH	1	0	0	1	1	0	1	0
-16	96H	1	0	0	1	0	1	1	0
-17	93H	1	0	0	1	0	0	1	1
-18	90H	1	0	0	1	0	0	0	0
-19	8CH	1	0	0	0	1	1	0	0
-20	89H	1	0	0	0	1	0	0	1
-22	83H	1	0	0	0	0	0	1	1
-24	7DH	0	1	1	1	1	1	0	1
-26	78H	0	1	1	1	1	0	0	0
-28	72H	0	1	1	1	0	0	1	0
-30	6DH	0	1	1	0	1	1	0	1
-32	68H	0	1	1	0	1	0	0	0
-34	64H	0	1	1	0	0	1	0	0
-36	5FH	0	1	0	1	1	1	1	1
-38	5BH	0	1	0	1	1	0	1	1
-40	57H	0	1	0	1	0	1	1	1
-42	52H	0	1	0	1	0	0	1	0
-44	4FH	0	1	0	0	1	1	1	1
-46	4BH	0	1	0	0	1	0	1	1
-48	47H	0	1	0	0	0	1	1	1
-50	42H	0	1	0	0	0	0	1	0
-52	40H	0	1	0	0	0	0	0	0
-54	3DH	0	0	1	1	1	1	0	1
-56	зан	0	0	1	1	1	0	1	0
-58	37H	0	0	1	1	0	1	1	1
-60	34H	0	0	1	1	0	1	0	0

Audio ICs

Gain (dB)	Hex. Notation	D7	D6	D5	D4	D3	D2	D1	D0
-62	32H	0	0	1	1	0	0	1	0
-64	2FH	0	0	1	0	1	1	1	1
-66	2DH	0	0	1	0	1	1	0	1
-68	2AH	0	0	1	0	1	0	1	0
-70	28H	0	0	1	0	1	0	0	0
-72	26H	0	0	1	0	0	1	1	0
-74	24H	0	0	1	0	0	1	0	0
-76	22H	0	0	1	0	0	0	1	0
-78	20H	0	0	1	0	0	0	0	0
-80	1EH	0	0	0	1	1	1	1	0
-82	1DH	0	0	0	1	1	1	0	1
-84	1BH	0	0	0	1	1	0	1	1
	00H	0	0	0	0	0	0	0	0

Treble / Bass setting list Treble Gain

Gain (dB)	Hex. Notation	D6	D5	D4	D3	D2	D1	D0
+15	7FH	1	1	1	1	1	1	1
+15	3FH	0	1	1	1	1	1	1
+14	36H	0	1	1	0	1	1	0
+12	32H	0	1	1	0	0	1	0
+10	2FH	0	1	0	1	1	1	1
+8	2DH	0	1	0	1	1	0	1
+6	2BH	0	1	0	1	0	1	1
+4	29H	0	1	0	1	0	0	1
+2	26H	0	1	0	0	1	1	0
0	20H	0	1	0	0	0	0	0
-2	1AH	0	0	1	1	0	1	0
-4	17H	0	0	1	0	1	1	1
-6	15H	0	0	1	0	1	0	1
-8	13H	0	0	1	0	0	1	1
-10	11H	0	0	1	0	0	0	1
-12	0EH	0	0	0	1	1	1	0
-14	0AH	0	0	0	1	0	1	0
-15	00H	0	0	0	0	0	0	0

Bass Gain

Gain (dB)	Hex. Notation	D6	D5	D4	D3	D2	D1	D0
+15	7FH	1	1	1	1	1	1	1
+15	3FH	0	1	1	1	1	1	1
+14	36H	0	1	1	0	1	1	0
+12	32H	0	1	1	0	0	1	0
+10	2FH	0	1	0	1	1	1	1
+8	2DH	0	1	0	1	1	0	1
+6	2BH	0	1	0	1	0	1	1
+4	29H	0	1	0	1	0	0	1
+2	26H	0	1	0	0	1	1	0
0	20H	0	1	0	0	0	0	0
-2	1AH	0	0	1	1	0	1	0
-4	17H	0	0	1	0	1	1	1
-6	15H	0	0	1	0	1	0	1
-8	13H	0	0	1	0	0	1	1
-10	11H	0	0	1	0	0	0	1
-12	0EH	0	0	0	1	1	1	0
14	0AH	0	0	0	1	0	1	0
-15	00H	0	0	0	0	0	0	0

BBE Gain Process

Gain (dB)	Hex. Notation	D7	D6	D5	D4
10.0	FH	1	1	1	1
9.0	EH	1	1	1	0
8.0	DH	1	1	0	1
7.0	CH	1	1	0	0
6.0	ВН	1	0	1	1
5.5	AH	1	0	1	0
5.0	9H	1	0	0	1
4.5	8H	1	0	0	0
4.0	7H	0	1	1	1
3.5	6H	0	1	1	0
3.0	5H	0	1	0	1
2.5	4H	0	1	0	0
2.0	3H	0	0	1	1
1.5	2H	0	0	1	0
1.0	1H	0	0	0	1
0.5	0H	0	0	0	0

Contour

Gain (dB)	Hex Notation	D3	D2	D1	D0
10.0	FH	1	1	1	1
9.0	EH	1	1	1	0
8.0	DH	1	1	0	1
7.0	СН	1	1	0	0
6.0	ВН	1	0	1	1
5.5	AH	1	0	1	0
5.0	9H	1	0	0	1
4.5	8H	1	0	0	0
4.0	7H	0	1	1	1
3.5	6H	0	1	1	0
3.0	5H	0	1	0	1
2.5	4H	0	1	0	0
2.0	3H	0	0	1	1
1.5	2H	0	0	1	0
1.0	1H	0	0	0	1
0.5	0H	0	0	0	0

Surround Gain setting list

Gain (dB)	Hex. Notation	D2	D1	D0
10	7H	1	1	1
9	6H	1	1	0
8	5H	1	0	1
7	4H	1	0	0
6	3H	0	1	1
5	2H	0	1	0
4	1H	0	0	1
3	0H	0	0	0

Reference value: The setting table is a reference value persistently and the sctual use condition sometimes changes the gain of volume, the tone, surround.

In case of data setting, we request confirmation.

(5) Notes on Data Transfer

This IC is equipped with the automatic increment function to improve the rate of data transfer. In addition to the data format shown in the under-mentioned Basic Format, the other data format Automatic Increment is also available for the data transfer.

1) Basic format

	MSB	LSB		MSB	LSB		MSB		LSB			
S	Slave Address		Α	Select Add	dress	Α		Data		Α	Р	

2) Automatic Increment (The Select Address is incremented (by one) according to the number of data.)

	MSB	LSB	MS	BB .	LSB		MSB	L	LSB			
s	Slave Address		Α	Select Address		Α		Data1, Data2, · · · · · , DataN	,	А	Р	

Example: <1> Data 1 shall be set as the data of the address specified by the Select Address.

- <2> Data 2 shall be set as the data of the address specified by the Select Address +1.
- <3> Data N shall be set as the data of the address specified by the Select Address +N-1.

3) Configuration Unavailable for Transfer (In this case, the Select Address 1 only is set.)

	MSB LSB		MSB LSB		MSB LSB		MSB	LSB		MSB LSB			
S	Slave Address	Α	Select Address	Α	Data	Α	Select Address 2	/	Α	Data	Α	Р	l

Note: If any data is sent as the Select Address 2 immediately after the Data, such data is recognized as the Data, not the Select Address 2.

•AGC

(1) Level Setting

The AGC suppression level can be set by the voltage of the AGDADJ terminal (31pin). Assuming that the suppression level is GC (mVrms) and the AGCADJ voltage is ADJ (V), setting can be expressed as follows:

The under-mentioned table shows a guideline of setting.

Suppression Level (mVrms)	AGCADJ Terminal Voltage (V)				
100	3.8				
200	3.45				
300	3.1				
400	2.75				

The level specified by the electrical characteristic is AGCADJ=3.45 (V) and the suppression level is approximately 200 (mVrms). Use the suppression level in a rage from 100 (mVrms) to 400 (mVrms). The under-mentioned chart shows the characteristic when the suppression level is set to 100 (mVrms), 200 (mVrms), 300 (mVrms) and 400 (mVrms).

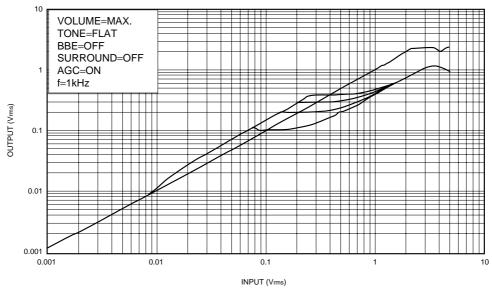
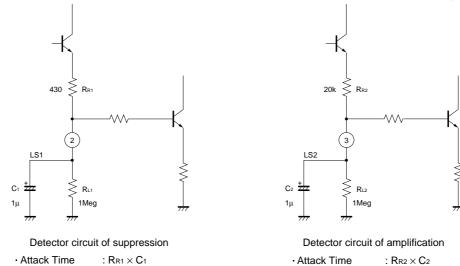


Fig.2 AGC characteristics

(2) Setting of Attack Time and Release Time

In this IC, the Attack Time and Release Time can be set in the boost side and cut side of AGC separately.



The Attack Time and Recovery Time shall be set by a resistor in IC and external capacitor and resistor. The internal resistance is $R_{R_1}=430\Omega$ and $R_{R_2}=20K\Omega$ (Typ).

· Recovery Time

: RL2 \times C2

If the constant of capacitor C² of LS2 decreases, an amplification starting point is shifted in a direction of smaller input voltage. Moreover, the distortion rate also changes and becomes worse.

If the constant of capacitor C^1 of LS1C¹ decreases, the distortion rate becomes worse. If the resistance value of R^{L1} increases, the suppression is reduced.

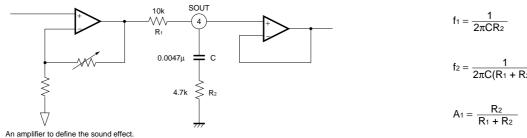
●SURROUND

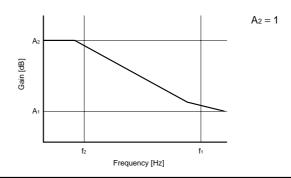
(1) Setting of Frequency Characteristic

· Recovery Time

: RL1 × C1

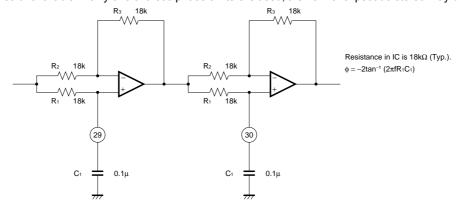
This IC has an output terminal (4pin) for the surround signal. The surround characteristic can be varied by adding an appropriate filter to this terminal. An example of characteristic that low-pass filter has been set is shown below:





(2) Setting of Phase Shifter

This IC contains two stages of phase shifters. If none of two stages of phase shifters are not used, the pseudo-stereo function is also unavailable. If only one of these phase shifters is used, the normal of pseudo stereo may be spoiled.



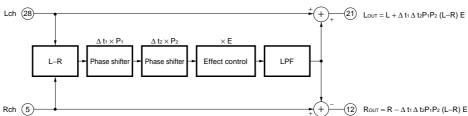
(3) Surround and Pseudo-Stereo Operation

∆t1∆t2: Time delayed by a phase shifter

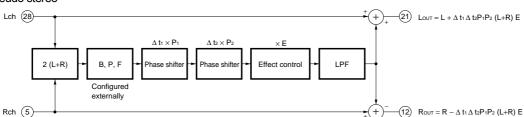
P1 P2: Attenuation made by a phase shifter

E: Surround effect

1) Surround



2) Pseudo stereo



The above-mentioned figures show the block diagram of surround and pseudo stereo ICs. The characteristics of surround and pseudo stereo can be varied by changing the effect. Moreover, the number of states of phase shifters can be increased by turning on a switch of loop. However, an operation becomes unstable if the gain of effect is increased while the switch of loop remains turning on. Therefore, the effect should be approximately 6 dB. Upon switching the surround and pseudo stereo to each other, be sure to turn on a switch at the stereo surround side of SSTE to prevent a shock sound.

●BBE

This IC is equipped with BBE to achieve the clear sound. The characteristic can be changed by an external constant. If any constant other than recommendable ones is used, please ask BBE for confirmation.

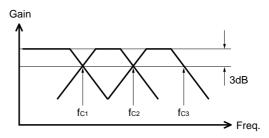
Frequency setting

$$f_{C1} = \frac{1}{2\pi \times 21.5k \times C1} \ = \ \frac{1}{2\pi \times 21.5k \times 0.033\mu} \ = \quad 224 Hz$$

$$fc_2 = \frac{1}{2\pi \times 21.5k \times C2} = \frac{1}{2\pi \times 21.5k \times 0.0033\mu} = -2.24kHz$$

$$f_{C3} = \frac{1}{2\pi \times 21.5k \times C3} = \frac{1}{2\pi \times 56.2k \times 47p} = 60.3kHz$$

C1=Capacity between 6pin-7pin, and 27pin-26pin. C2=Capacity between 8pin-9pin, and 25pin-24pin.

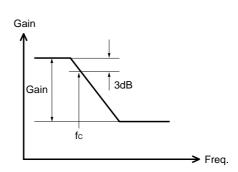


fc3 is fixed at the inside.

●Tone control

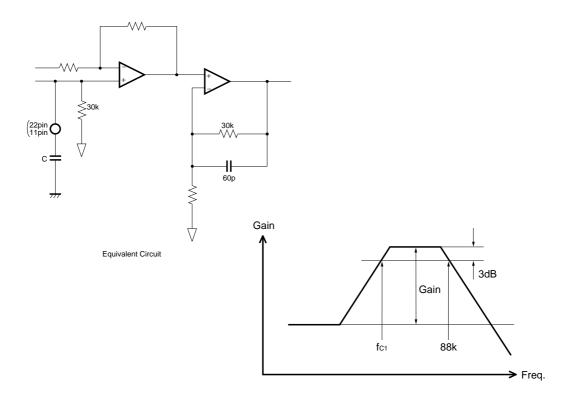
Setting of bass frequency

$$fc = \frac{1}{2\pi \times 30k \times C} \text{ (Hz)}$$

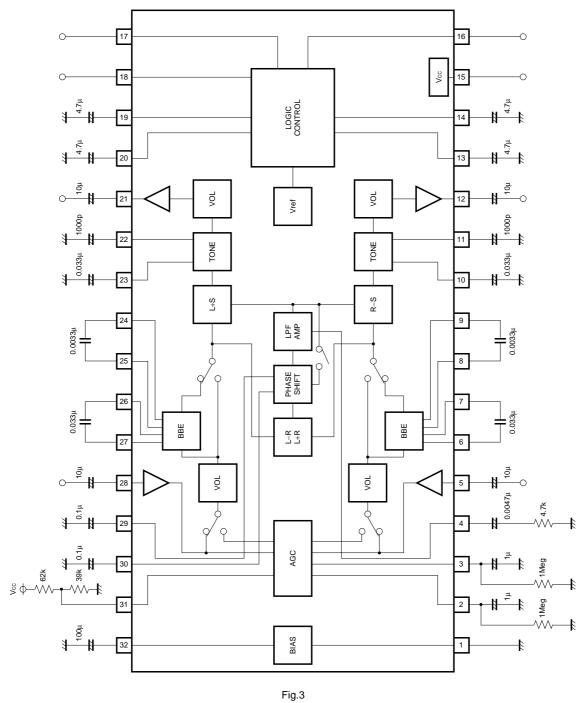


Setting of treble frequncy

$$\begin{split} f_{C1} &= \frac{1}{2\pi \times 30k \times C} \text{ (Hz)} \\ f_{C2} &= \frac{1}{2\pi \times 30k \times 60p} \ = \quad 88k \text{ (Hz)} \end{split}$$

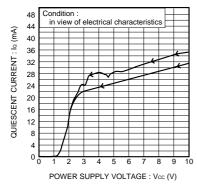


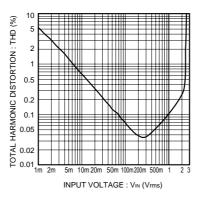
Application



23/27

•Electrical characteristics curve





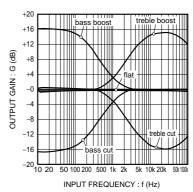
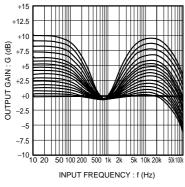


Fig.4 Quiescent current

Fig.5 THD

Fig.6 Tone frequency



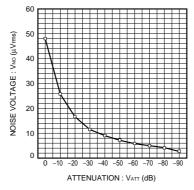


Fig.7 BBE frequency

Fig.8 Noise level

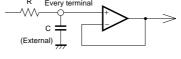
Operation notes

- We trust that an example of application circuits are recommendable and we would like to ask you to check the undermentioned notes and the characteristics carefully. If you will modify and external circuit constant upon use, you should allow for not only static characteristics but also transient characteristics, unexpected variation of external components and our ICs.
- 2. Operating power supply voltage range

Basic circuit function and operation can be guaranteed within the operating temperature range and within the operating power supply voltage range. Upon use, check those ranges carefully and specify the content, element, voltage and temperature.

3. Step switching noise

In an example of application circuit, an example of constant is set on VC1, VC2, TC and BC terminals. This constant varies depending on signal level setting, actual wiring pattern, etc. Specify each constant under careful study and examination. The internal equivalent circuit is shown below. (A primary integration circuit is set for gradual variation.)



	R value (kΩ)
VC1, VC2, TC, BC	30

4. Level setting of volume and tone

Attenuation to control serial data is stated as a reference value in our specifications.

An internal D/A converter is configured by the R-2R method and, therefore, there is any data also in an area in which some data are not consecutive. Use is for fine adjustment.

However, the volume must be within 8 bits (256 steps) and the tone must be 7 bits (64+1 steps).

5. I²C BUS control

High-frequency digital signal is inputted into the SCL terminal and SDA terminal. Therefore, However, wire not to interfere any analog signal system line.

6. Power-on Reset

This IC contains a circuit for initialization when the power supply turns on. Every channel volume has been set to become $-\infty$ when the power supply turns on. When the power supply is turned ON once and OFF and then ON again immediately, the said description may not be achieved if any load remains in a capacitor. In this case, apply muting until a command of I²C BUS has been sent.

7. Capacitor of VREF (8pin)

 $100\mu F$ is recommended as the capacity of power supply filter attached to VREF. If this capacity is decreased, the maximum attenuation of volume is deteriorated and the cross-talk also tends to become worse. This IC contains a precharge circuit and discharge circuit for capacitor attached to VREF.

●BBE process

The BBE sound processor considers a loudspeaker and amplifier as total audio system, reproduces accurately "Rise of Sound" which characterizes the sound, by an appropriate signal processing at a stage before amplifier input, and makes the playback sound an original one as naturally as possible.

Problem in Sound Reproduction with Audio System and BBE Process

In general, for the natural sound, treble harmonic element is generated first and then bass basic wave element is produced. This is the same with the attack part which shows the characteristics of various musical instruments. The amplitude element, which forms a frequency element and envelope at the rise of sound, expresses the character of the sound. Therefore, to reproduce any sound with a playback system, it is very important to express accurately the rise of sound against the original sound. However, there is unavoidable mismatch between a loudspeaker and amplifier of today's audio playback system.

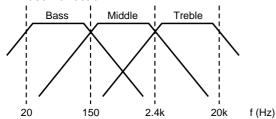
For example, a power amplifier with transistor operates as constant-voltage source, but mismatch cannot be avoided because one loudspeaker is a current element. Moreover, the impedance characteristic of loudspeaker is affected considerably by electric reactance of voice coil or mechanical reactance of cone assembly. As a result, the rise of sound is distorted and the phase of playback sound is deviated. Furthermore, due to the increase of treble impedance, the loudspeaker amplitude is reduced and the harmonic element is deteriorated. So the treble element is easy to be masked by a consequent middle tone element of high level, and the rise of sound is hard to be produced accurately.

BBE has been developed to solve those problems. BBE is a technology to reproduce the sound clearness more naturally by moving the delayed harmonic before the basic wave first to construct the same wave as that of the natural sound and then boosting slightly the treble which is easy to be attenuated. Because of the synergistic effect of phase correction and treble boost, the same clearness can be obtained by approximately half boost in comparison with a simple boost of equalizer. It has been ten years or more since BBE was introduced into many recording studios, PA, SR sites and broadcasting stations, and 100,000 or more units of BBE for professional have been using. BBE is designated by many musicians to improve the sound of vocal and musical instruments.

Principle of Operation

To solve the problems in audio playback system mentioned in the previous page, the BBE processor processes a signal as follows:

Phase Correction



By dividing the input signal to three frequency bands, "Bass" (20 to 150 Hz), "Middle" (150Hz to 2.4kHz) and "Treble" (2.4k to 20kHz), and by adding them again, the phase difference –360° in Treble and –180° in Middle against Base are generated. These phase differences adjusts the time delay characteristic in every frequency band and minimizes the distortion of the rise of sound.

Revision of harmonic element

Gain is applied to Treble, because the harmonic element (Treble element), of which gain is expected to be deteriorated depending on the loudspeaker characteristic, must be enhanced. However, if Treble is clear, it may seem that Bass is insufficient. This can be corrected by applying the gain to Bass.

There are many audio system characteristics. The most suitable correction effect for your system can be obtained by BBE.

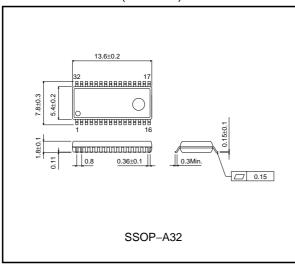
•License agreement about patent and trademark

BBE is a registered trademark of BBE Sound Inc. Only authorized party, who is permitted to use the trademark and patent of BBE, can supply and sell BH3868BFS.

For such trademark and patent of BBE, please contact :

BBE Sound Inc. 5381 Production Drive Huntington Beach, CA 92649 Tel:(714)897-6766 Fax:(714)896-0736

●External dimensions (Units : mm)



Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any
 means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the
 product described in this document are for reference only. Upon actual use, therefore, please request
 that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard
 use and operation. Please pay careful attention to the peripheral conditions when designing circuits
 and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or
 otherwise dispose of the same, no express or implied right or license to practice or commercially
 exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document use silicon as a basic material.
 Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

